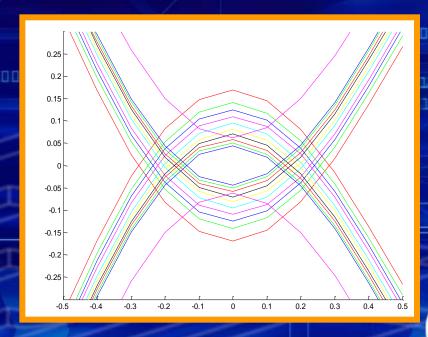
Package Modeling Decisions

IBIS ATM Teleconference September 17, 2013





© Mentor Graphics Corp., 2013, Reuse by written permission only. All rights reserved.

Arpad Muranyi

araphas and a

Overview of BIRD 125

- The BIRD makes use of IBIS-ISS to describe the package
- IBIS-ISS replaces the R, L, C matrix or Fork/Endfork syntax
- The IBIS-ISS subcircuits are instantiated with a syntax similar to [External Circuit]
- Implicit and Explicit on-die nodes (pads) are declared so connections can be made to them for IBIS-ISS subcircuits
- Tries to minimize syntax changes to the IBIS specification
- Splits/joins in the package or on-die interconnect could be addressed using BIRD 145
- Sliding package model needs more work in the BIRD
- Stacked die modeling not addressed, need other BIRD(s)



Overview of BIRD 145

- The BIRD makes provisions for connecting [Model]s and [External Model]s in series
- This allows on-die interconnect modeling in [External Circuit] to be used with legacy [Model]s (and [External Model]s)
- The [Model Call] syntax allows for defining die pad names which are useful for making connections to package models
- Very small change to the specification, quick path to success
- With a little "poetic license" this BIRD could also be used for package modeling
 - zeroing out the normal package parameters: pin=pad



Overview of EMD

- The proposal introduces a brand new syntax to supersede EBD
 - could be written with the tree or keyword style
 - replacement of path syntax with subcircuits
 - intended to model "Modules"
 - could implement package in EMD
 - not a good solution for IBIS Component packaging problem
- The syntax is more efficient and compact than the familiar IBIS syntax
- The concept is based on the familiar EBD specification
- Since it is evolving as we speak, all of the current modeling needs are addressed
 - sliding package modeling, etc...
- EMD might take over the "cockpit" role from .ibs files
 - instantiates IBIS models using "U" designators in .ibs files
 - where is the package, in .ibs, .emd, or both?
 - the definition of what "component" is may change



Decision time

- BIRD 145 could provide a solution very quickly
 - could be a useful interim solution while we wait for EMD
- BIRD 125 is complete, but would need more work to address some needs identified recently (sliding package, stacked die)
- EMD needs quite a bit more detail work
- Is it a good idea to have both in future IBIS specifications?
 - the specification would get unnecessarily large
 - model makers might get confused on which method to use
 - tool vendors might implement only their favorite solution which can lead to models which only work in some tools



